tty. Docket No.: 33773M034		
o the Honorable Commissic	03-28-2002	1046 U.S.
Please record the attached	102035029	thereof.
. Name(s) of conveying party(ies): 3-20-02	
MATSUYA	o YAMAMOTO, Yutaka KOMA	, Masashi AOKI and Naohiro
. Name(s) and Address(es) of	receiving party(ies):	
DISCO CORPORATION 14-3, Higashi Kojiya 2-cho Ota-ku, Tokyo, 144-8650 J	APAN	
. Nature of conveyance: Assig Execution Date: March 4, 200		
A. Patent Application No.(s):Application execution dateB. Patent No.(s):		
•	0	·
(Enclosed. Please charge any defi		ounsel's deposit account.)
Deposit Account No.: 02-430	0	
	OO NOT USE THIS SPACE	
. Statement and Signature: To the best of my knowledge and Itached copy is a true copy of the ori	ginal document.	an 00:
Signature: 272 Acceptable March 20, 2002)5 101009(
		PATENTS PARENTI 000000 101000001 10000001 10000001 1000000

Assignment

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned, Sinnosuke SEKIYA, Setsuo YAMAMOTO, Yutaka KOMA, Masashi AOKI and Naohiro MATSUYA, all citizens of Japan, residing respectively at Tokyo, Japan, Tokyo, Tokyo, Japan, Tokyo, Tokyo, Tokyo, Tokyo, Japan, Tokyo, Tok

Hereby sell, assign and transfer to Disco Corporation a corporation of Japan having a place of business at 14-3, Higashi Kojiya 2- chome, Ota - ku, Tokyo 144-8650 Japan

its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith March 4, 2002, and is entitled Polishing Tool and Polishing Method and Apparatus Using Same, and in and to said application and all divisional, con-

tinuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: March 4, 2002	D'innosure Dekrya(LS.)		
	Setuc Yamamoto	(L.S.)	
	yntaka koma	(L.S.)	
Witness	Masashi Aoki	(L.S.)	
	Nachiro Matsuya	(L.S.)	
		(L.S.)	

RECORDED: 03/20/2002

PATENT REEL: 012714 FRAME: 0447